



# Materials, Design & Manufacturing Facility (CWB) 材料、設計和製造中心(清水灣)

# MDMF (CWB)

# Introduction

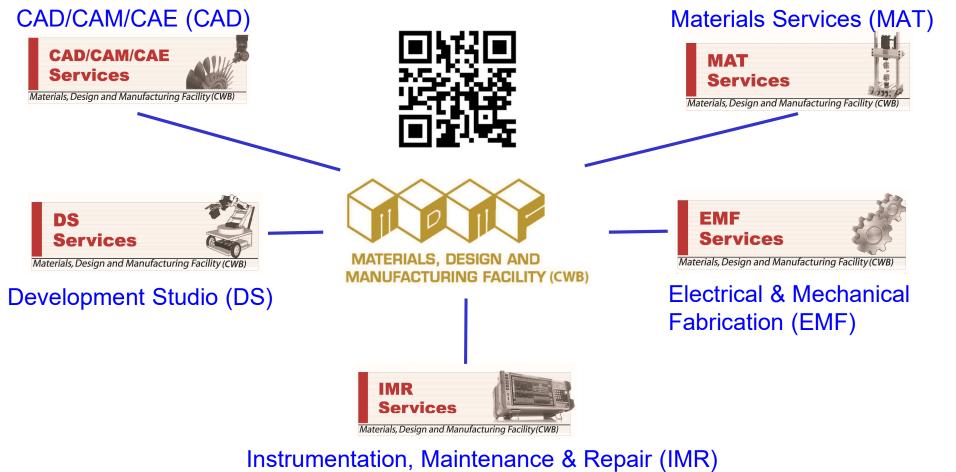
08/Dec/2021







#### **Our Services – 5 Units**



08/Dec/2021

MDMF (CWB)

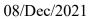






#### **Services Scope – EMF**

- Engineering design and fabrication supporting services
- Sophisticated mechanical & electrical parts/equipment for the university and industrial collaboration projects
  - Parts/equipment/controller is not available in market
  - Multidisciplinary and application oriented activities



MDMF (CWB)





#### **Services Scope – EMF**

Ŵ







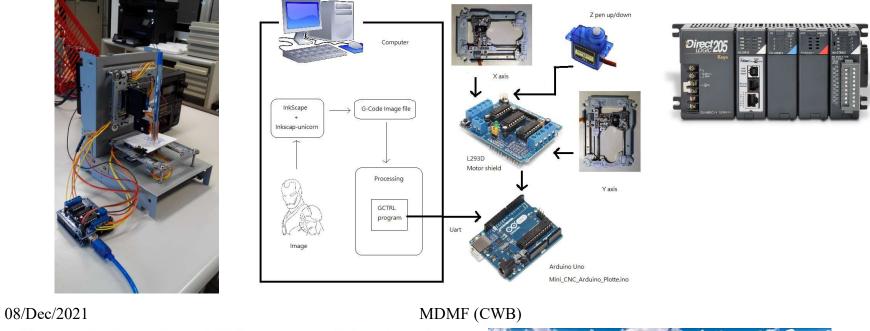
5

香港科技大學

#### **Services Scope – DS**

#### • Controller design and fabrication supporting

- Controller boards, MCUs, cam, motors, sensors (environmental, motion, light, etc.)
- Eclipse for android development, Arduino IDE, Raspberry Pi, PLC
- PCB prototyping







#### **Services Scope - IMR**

- Repair and maintenance of equipment
  - Scientific instruments, computer control machineries, laboratory equipment, and electrical safety
  - Especially for those which are no longer supported by the manufacturers
- Calibrations for multimeter, power meter, data logger, radiation monitor and temperature sensors





#### **Services Scope - IMR**

Ŵ

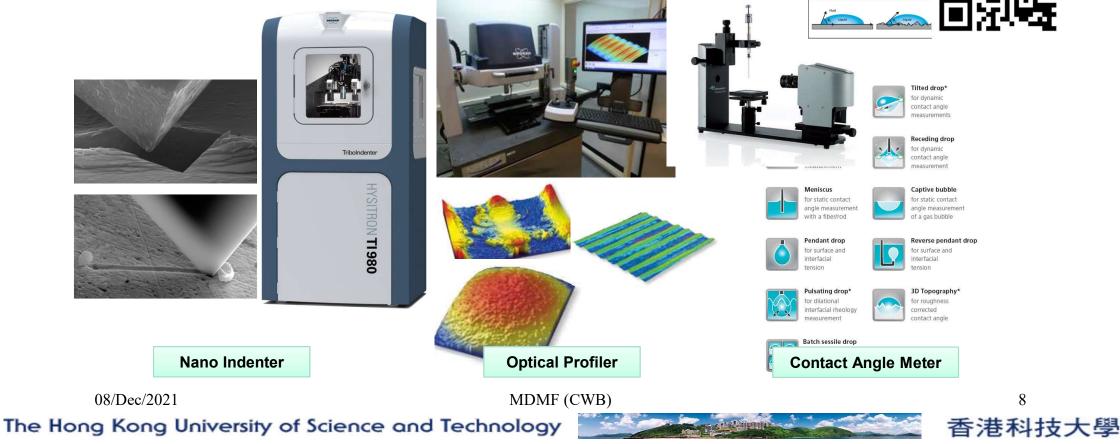






#### **Services Scope - CAD**

- Nano-measurement
  - Nano indenter, 3D surface metrology, optical profiler, contact angle meter

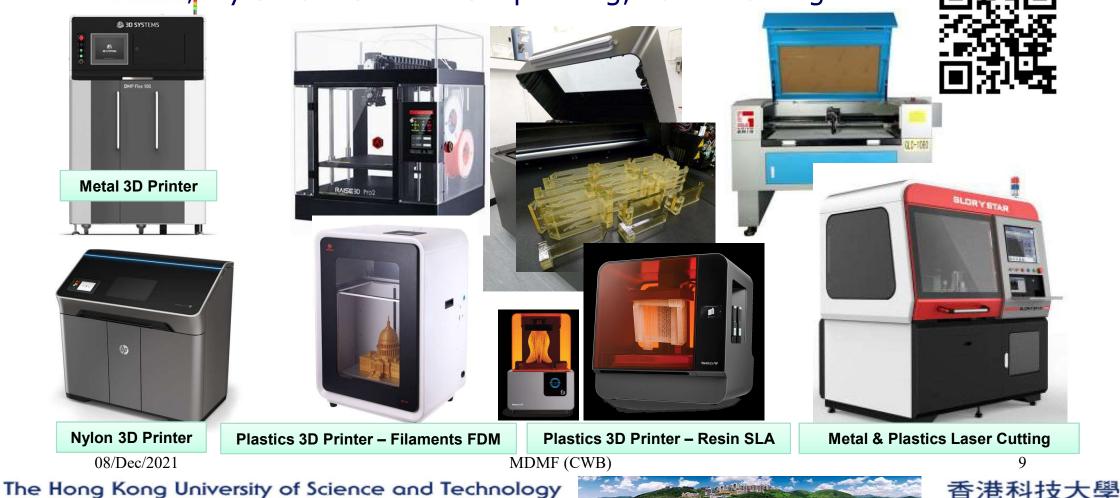






#### **Services Scope - CAD**

• Metal, Nylon & Plastics - 3D printing, Laser cutting

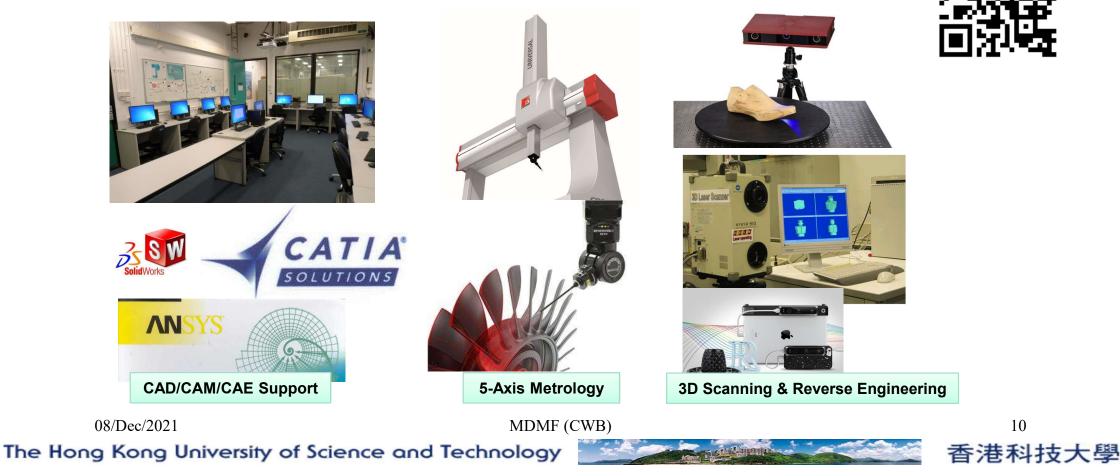






#### **Services Scope - CAD**

CAD/CAM/CAE system support, 5-axis metrology, 3D scanning, reverse engineering







- Mechanical Testing
  - also known as destructive testing, reveals the properties of a material under dynamic or static force



MTS 810 5KN to 100KN



MTS 858 15kN Axial and 100 Nm Torsion

MDMF (CWB)

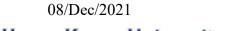


11

香港科技大學



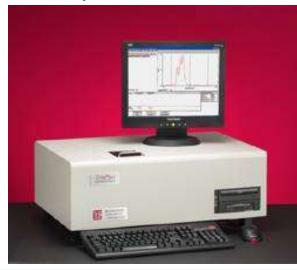
MTS 858 Mini Bionix 25KN Axial, 250 Nm Torsional







- Inspection and Failure Analysis
  - determining the root cause of parts/assembly failure and working out the means for correcting and preventing current/future problems



Zeta Potential / Nano-particle Analyzer: ZetaPlus Zeta Potential Range : -150 to + 150 mV Size Range : 10nm to30µm



TecScan 7 Axis Immersion Scanner 1600mm x 800mm x 800mm sample length





C-SAM: Sonix Quantum 350H Spatial resolution:0.5 μm Depth resolution: 8 μm

08/Dec/2021







- Inspection and Failure Analysis
  - determining the root cause of parts/assembly failure and working out the means for correcting and preventing current/future problems



Particle Size Analyzer Measurement capability from 0.01 to 2800 microns



Microscope: Topcon TMM-13OZ Measuring range: 130 x 130 x 50 mm Minimum indication: 0.001 mm Accuracy: (3 + 2.5L/100) μm

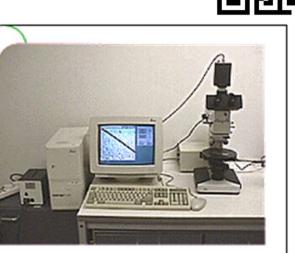


Image Processing System Leica QUANTIMET 500+

08/Dec/2021







- Sample Processing
  - processing of metal heat treatment, polymer and carbon composite



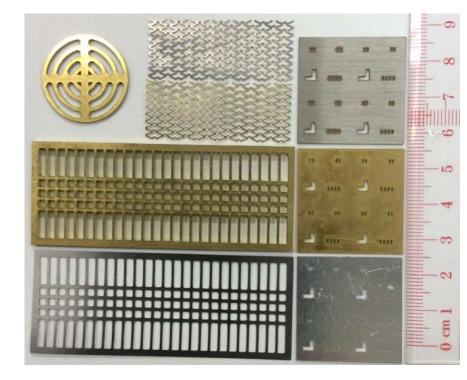
ŵ



# **Project – Metal Laser Cutting**

#### • Fiber laser cutting machine of 1.5kW

- Working area: 630 x 530 x 90 mm
- 4th rotary axis for round pipe cutting



Mild Steel (mm) 0.2 ~ 16 Stainless Steel (mm) 0.2 ~ 8 Aluminum (mm) 0.5 ~ 5 Copper (mm) 0.5 ~ 2 Brass (mm) 0.5 ~ 4





08/Dec/2021

MDMF (CWB)

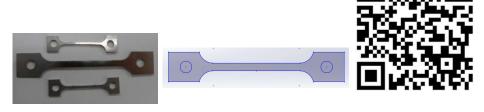






# **Project – Metal Laser Cutting**

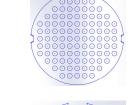
- Examples
  - SMA specimens
    - Tensile specimen:
      - Materials / Thickness: 1mm
      - Production time: 45 second
    - Crack specimen:
      - Materials / Thickness: 1.5mm
      - Production time:1 min.





- S.S. Filter specimen
  - Materials / Thickness: 1.2mm
  - Production time:8min. 30 second
- Ti Electrode specimen
  - Materials / Thickness: 1mm
  - Production time: 2min.







08/Dec/2021

MDMF (CWB)







# **Project – Laser Marking & Engraving**

- Laser Marking Machine
  - 10W fiber laser
  - Max. size is 110mm X 110mm





08/Dec/2021

MDMF (CWB)

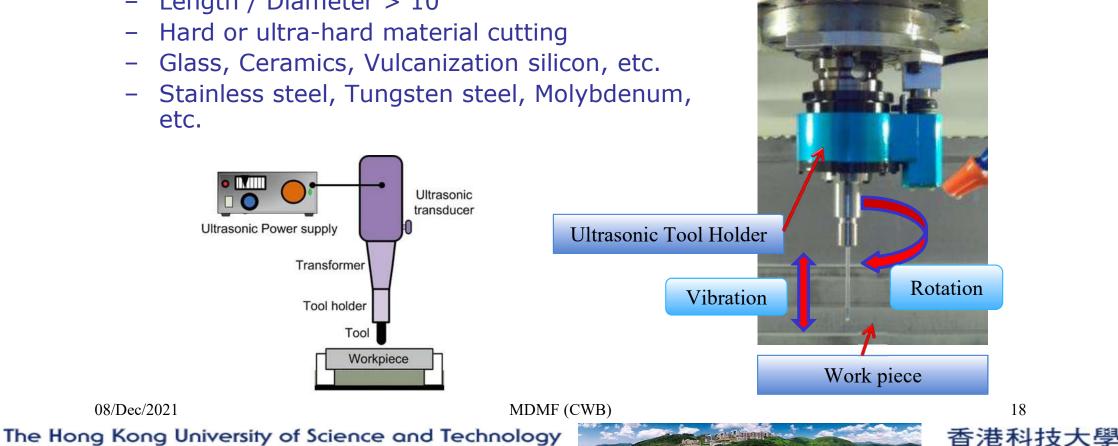






#### **Project – Ultrasonic-Assisted Machining**

- Ultrasonic tool holder
  - Fast, small and deep hole machining
  - Length / Diameter > 10 —
  - Hard or ultra-hard material cutting
  - Glass, Ceramics, Vulcanization silicon, etc. \_
  - Stainless steel, Tungsten steel, Molybdenum, etc.

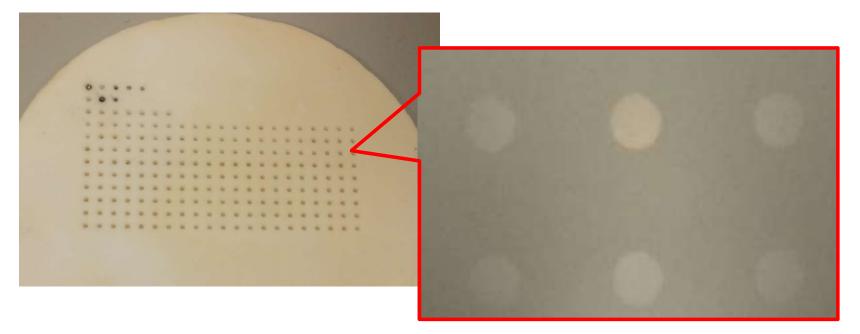






### **Project – Ultrasonic-Assisted Machining**

- Examples
  - Alumina, Small hole drilling / milling (blind hole)
    - Hole diameter = 1.2mm; depth = 1.4mm
    - # of holes to be drilled per workpiece = 400







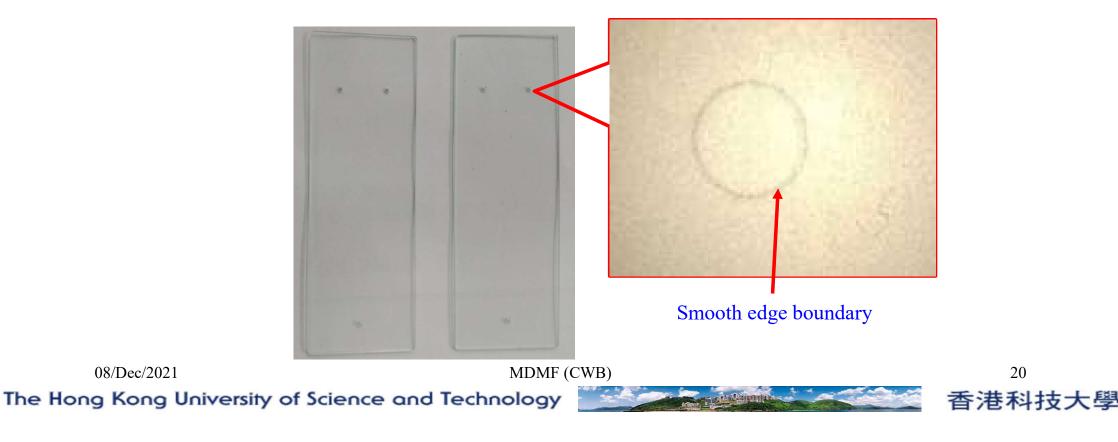


# **Project – Ultrasonic-Assisted Machining**

Examples 

08/Dec/2021

- Glass, Small hole drilling (thru' hole)
  - Hole diameter = 0.6mm; Glass plate thickness = 1mm
  - # of holes to be drilled per workpiece = 4 •







21

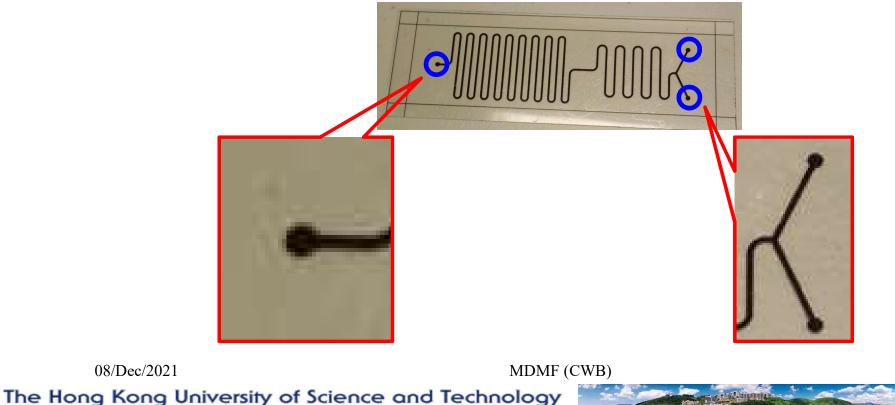
香港科技大學

## **Project – Ultrasonic-Assisted Machining**

Examples 

08/Dec/2021

- Glass channel, Small hole drilling (thru' hole) —
  - Hole diameter = 1.0mm; depth = 1mm
  - # of holes to be drilled per workpiece = 3







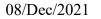
22

香港科技大學

### **Project – Ultrasonic-Assisted Machining**

- Examples
  - Stainless steel, Small hole drilling (blind hole)
    - Hole diameter = 0.2mm and 0.9mm
    - Depth = 5mm and 20mm
  - SMA Shape Memory Alloy, Small hole drilling (thru' hole)
    - Hole diameter = 0.075m
    - Thickness = 2mm



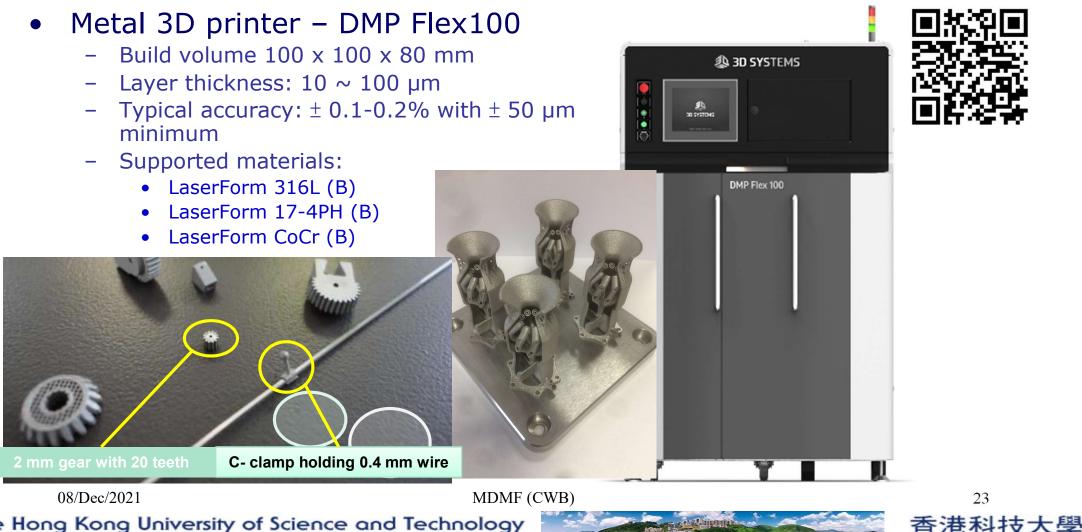


MDMF (CWB)



# **Project – Metal 3d Printing**

Ŵ





# **Project – Nylon 3d Printing**

#### • Nylon 3D printer – HP Jet Fusion 540

- Build volume 332 x 190 x 248 mm
- Layer thickness: 0.08 mm
- Typical accuracy: ± 0.3% with ± 0.2 mm minimum
- Supported materials:
  - Nylon PA12

Ŵ











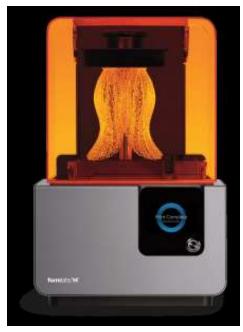
60





#### • Desktop SLA 3D printer – Form 2

- Build volume 145 x 145 x 175 mm
- Layer Thickness 0.025 0.1 mm
- File Formats for Printing: STL, OBJ
- Professional print quality









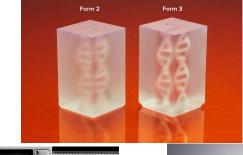






#### • Desktop SLA 3D printer – Form 3L

- Build volume 335 x 200 x 300 mm
- Layer Thickness 0.025 0.3 mm
- File Formats for Printing: STL, OBJ
- Low Force Stereolithography (LFS)<sup>™</sup>



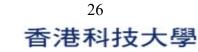








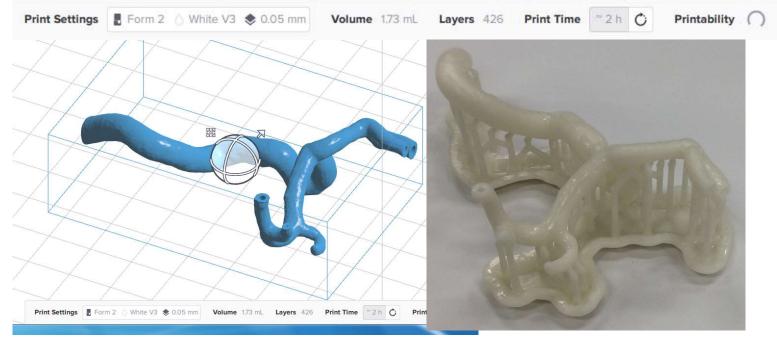
08/Dec/2021 MDMF (CWB)
The Hong Kong University of Science and Technology







- Examples
  - Blood vessel
    - Materials Standard White
    - Minimum feature size = 0.5mm

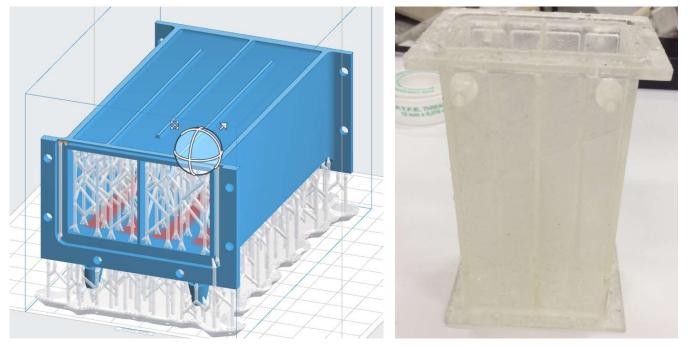


08/Dec/2021 MDMF (CWB) 27
The Hong Kong University of Science and Technology 香港科技大學





- Water channel model
  - Materials Standard Clear
  - Channel size = 2.5mm
  - Internal water circulation



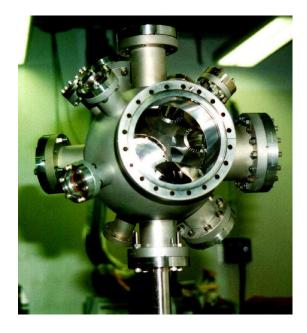


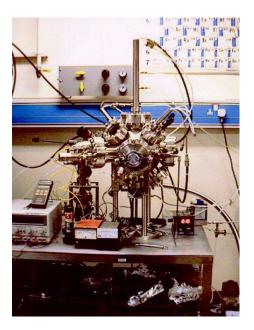




# **Project – High Vacuum Chamber**

- High vacuum stainless steel chamber
  - Design and build an enhanced HVC with tailor made functionalities
  - Vacuum level less than 10<sup>-8</sup> torr









# **Project – Reactive Ion Etcher**

- Design and build the reactive ion etcher in wafer fabrication
  - Tailor made functionalities





Ŵ

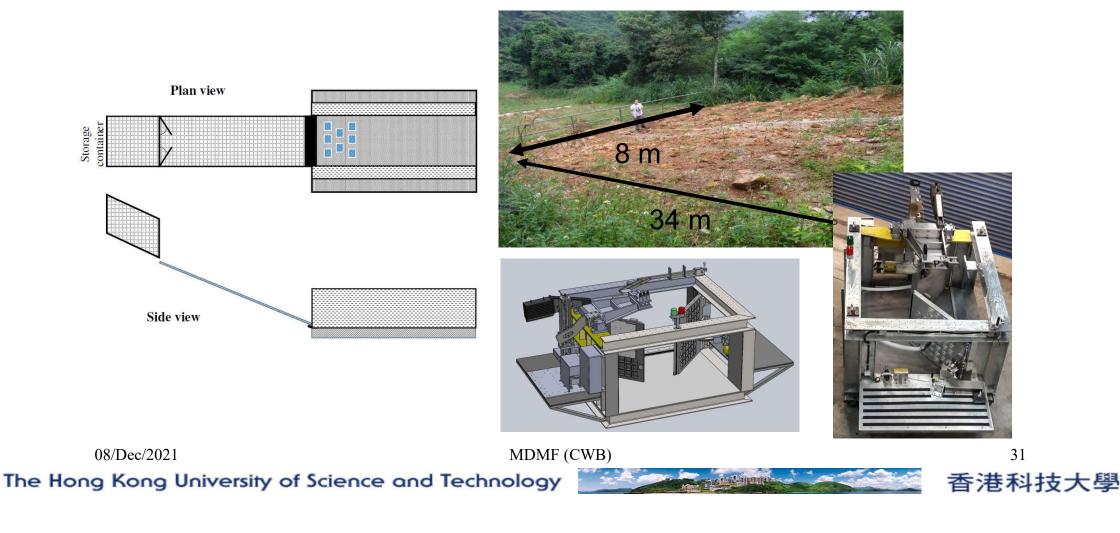






# **Project – Soil Retaining Gate**

• Design and build the soil retaining gate of a flume model







# **Project – Shaking Platform**

- Design and build the shaking platform for
  - Active vibration control of earthquake / wind excited structures
  - Assessment of motion acceptance criteria for human occupancy in the design of flexible structures









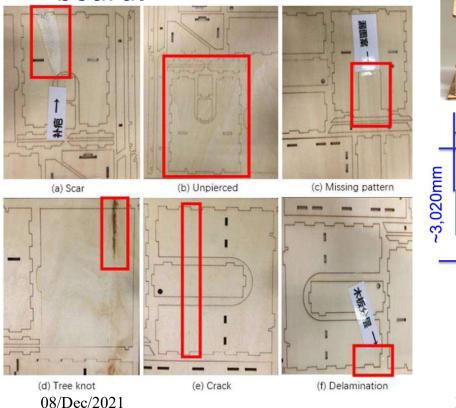
#### **Project – Automatic Flaws Inspection System**

 To automate the detection process of natural and manufacturing flaws before/after laser cutting a plywood board.

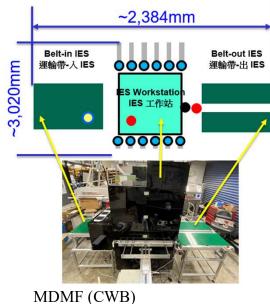


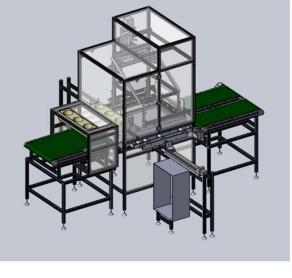
33

香港科技大學







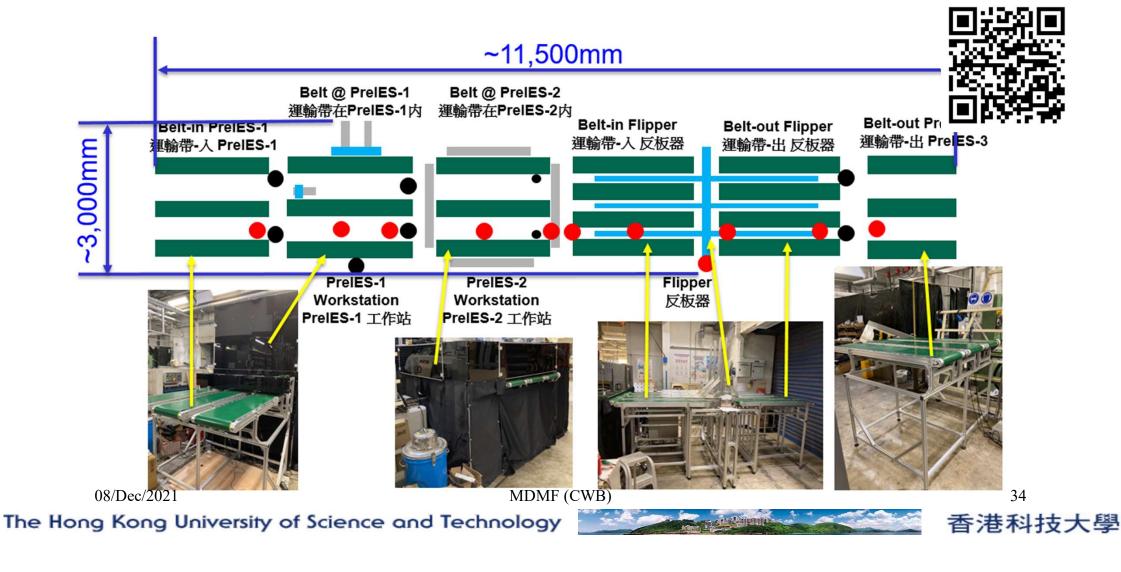








#### **Project – Automatic Flaws Inspection System**

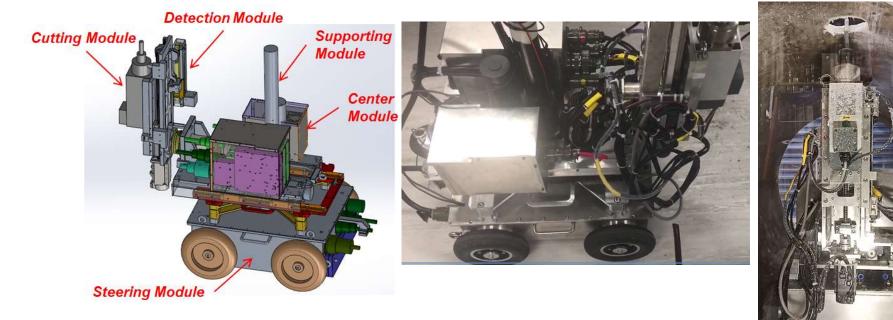






# **Project – CIPP Repair Robot Cutter**

• To develop an automatic robot cutter that can cut the lateral connection branch opening during underground drainage pipe repairing in Hong Kong.



 08/Dec/2021
 MDMF (CWB)
 35

 The Hong Kong University of Science and Technology
 香港科技大學





36

香港科技大學

### **Project – Diamond Sorter**

- An automation system to sort gems into different size / color / shape / transparency grades and to measure the cutting / cracks on diamonds
  - Involves the R&D of a vision system, image processing module and an electromechanical mechanism





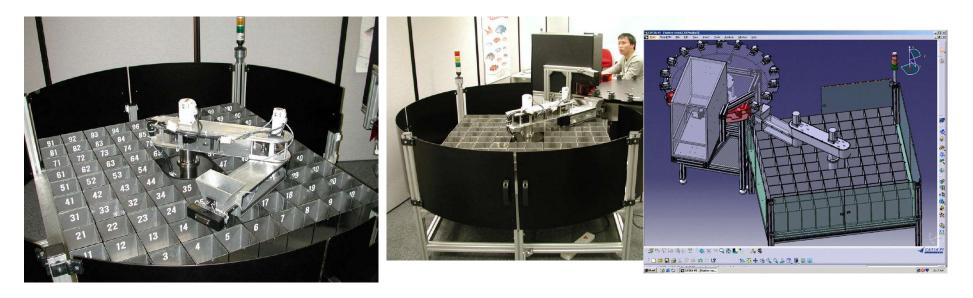




#### **Project – Feather Sorter**

- To sort feathers of different features for the shuttlecock manufacturing industry.
  - Involves the R&D of a turning table, an image processing system and a robotic arm, which selects feather into the bin matrix according to their degree of curvature











# **Project – Controller for Embroidery Machine**

- Design and develop a controller to control the embroidery machine more precisely and at higher speed, with less vibration
  - Linux in an embedded system, with advanced control algorithms for accurate positioning, tension control, automatic compensation

of vibration





The Hong Kong University of Science and Technology





38





#### **Engineering / Robotic Design Competition**

- RoboCon
- ROV
- Cybathlon
- Pedal Kart
- Power Bike











08/Dec/2021 MDMF (
The Hong Kong University of Science and Technology

